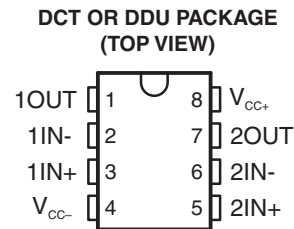


FEATURES

- Low Supply Current...20 μ A Typ
- Single Power Supply
- Rail-to-Rail Common-Mode Input Voltage Range
- Push-Pull Output Circuit
- Low Input-Bias Current



APPLICATIONS

- Battery Packs for Sensing Battery Voltage
- MP3 Players, Digital Cameras, PMPs
- Cellular Phones, PDAs, Notebook Computers
- Test Equipment
- General-Purpose Low-Voltage Applications

DESCRIPTION/ORDERING INFORMATION

The TLV7256 is a CMOS-type general-purpose dual comparator capable of single power-supply operation and using lower supply currents than the conventional bipolar comparators. Its push-pull output can connect directly to local ICs such as TTL and CMOS circuits.

ORDERING INFORMATION⁽¹⁾

| T_A | PACKAGE ⁽²⁾ | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|---------------|------------------------|--------------|-----------------------|------------------|
| -40°C to 85°C | SSOP – DCT | Reel of 3000 | TLV7256IDCTR | PREVIEW |
| | | Reel of 250 | TLV7256IDCTT | |
| | VSSOP – DDU | Reel of 3000 | TLV7256IDDUR | YAUA |

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.
 (2) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

Typical Application Circuit

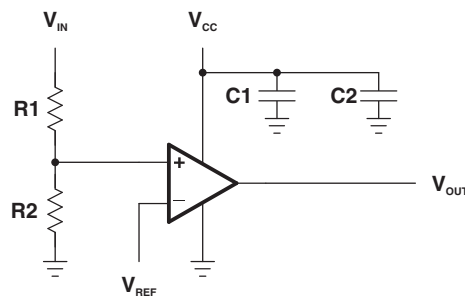


Figure 1. Threshold Detector



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

TLV7256 DUAL COMPARATOR

SLCS147A–OCTOBER 2006–REVISED JANUARY 2007

Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| | | MIN | MAX | UNIT |
|------------------|--|------------------|------------------|------|
| V _{CC} | Supply voltage | 1.5 | 7 | V |
| V _{ID} | Differential input voltage | | | V |
| V _I | Input voltage | V _{CC-} | V _{CC+} | V |
| I _O | Output current | | ±35 | mA |
| θ _{JA} | Thermal resistance, junction to ambient ⁽²⁾ | DCT package | 220 | °C/W |
| | | DDU package | 227 | |
| P _D | Power dissipation | DCT package | 250 | mW |
| | | DDU package | 200 | |
| T _A | Operating free-air temperature range | –40 | 85 | °C |
| T _{stg} | Storage temperature range | –55 | 125 | °C |

(1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) Package thermal impedance is calculated according to JESD 51-7.

Recommended Operating Conditions

| | | MIN | MAX | UNIT |
|-----------------|--------------------------------|-----|-----|------|
| V _{CC} | Supply voltage | 1.8 | 5 | V |
| T _A | Operating free-air temperature | –40 | 85 | °C |

Electrical Characteristics
 $V_{CC+} = 5\text{ V}$, $V_{CC-} = \text{GND}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | T_A | MIN | TYP | MAX | UNIT | |
|--------------|-----------------------------|--|---------------|------|------|----------|---------------|--|
| V_{IO} | Input offset voltage | | 25°C | | ±2 | ±7 | mV | |
| | | | –40°C to 85°C | | | ±8 | | |
| I_{IO} | Input offset current | | 25°C | | 2 | | pA | |
| I_I | Input bias current | | 25°C | | 4 | | pA | |
| V_{CM} | Common-mode input voltage | | 25°C | 0 | | V_{CC} | V | |
| CMRR | Common-mode rejection ratio | $\Delta V_{CM} = 5\text{ V}$ | 25°C | 48 | 65 | | dB | |
| | | $0 \leq V_{CM} \leq 5\text{ V}$ | –40°C to 85°C | 48 | | | | |
| I_{CC} | Supply current | Output = High, $V_{IN} = 5\text{ V}$ | 25°C | | 37 | 51 | μA | |
| | | Output = Low, $V_{IN} = 5\text{ V}$ | | | 40 | 60 | | |
| | | Output = High, $V_{IN} = 5\text{ V}$ | –40°C to 85°C | | | 61 | | |
| | | Output = Low, $V_{IN} = 5\text{ V}$ | | | | 70 | | |
| | | Output = High, $V_{IN} = 2.5\text{ V}$ | 25°C | | 20 | 32 | | |
| | | Output = Low, $V_{IN} = 2.5\text{ V}$ | | | 26 | 42 | | |
| | | Output = High, $V_{IN} = 2.5\text{ V}$ | –40°C to 85°C | | | 40 | | |
| | | Output = Low, $V_{IN} = 2.5\text{ V}$ | | | | 53 | | |
| A_{VD} | Voltage gain | $V_D = 3\text{ V}$, $1\text{ V} \leq V_{OUT} \leq 4\text{ V}$ | 25°C | | 88 | | dB | |
| I_{sink} | Sink current | $V_{OL} = 0.5\text{ V}$ | 25°C | 25 | 33 | | mA | |
| | | | –40°C to 85°C | 20 | | | | |
| I_{source} | Source current | $V_{OH} = 4.5\text{ V}$ | 25°C | 30 | 35 | | mA | |
| | | | –40°C to 85°C | 25 | | | | |
| V_{OL} | Low-level output voltage | $I_{sink} = 5\text{ mA}$ | 25°C | | 0.07 | 0.12 | V | |
| | | | –40°C to 85°C | | | 0.20 | | |
| V_{OH} | High-level output voltage | $I_{source} = 5\text{ mA}$ | 25°C | 4.9 | 4.93 | | V | |
| | | | –40°C to 85°C | 4.85 | | | | |

TLV7256 DUAL COMPARATOR

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Electrical Characteristics

$V_{CC+} = 2.7\text{ V}$, $V_{CC-} = \text{GND}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | T_A | MIN | TYP | MAX | UNIT |
|--------------|-----------------------------|--|---------------|------|------|----------|---------------|
| V_{IO} | Input offset voltage | | 25°C | | ±2 | ±8 | mV |
| | | | –40°C to 85°C | | | ±9 | |
| I_{IO} | Input offset current | | 25°C | | 2 | | pA |
| I_I | Input bias current | | 25°C | | 4 | | pA |
| V_{CM} | Common-mode input voltage | | 25°C | 0 | | V_{CC} | V |
| CMRR | Common-mode rejection ratio | $\Delta V_{CM} = 2.7\text{ V}$ | 25°C | 42 | 57 | | dB |
| | | $0 \leq V_{CM} \leq 2.7\text{ V}$ | –40°C to 85°C | 42 | | | |
| I_{CC} | Supply current | Output = High, $V_{IN} = 2.7\text{ V}$ | 25°C | | 30 | 55 | μA |
| | | Output = Low, $V_{IN} = 2.7\text{ V}$ | | | 36 | 55 | |
| | | Output = High, $V_{IN} = 2.7\text{ V}$ | –40°C to 85°C | | | 65 | |
| | | Output = Low, $V_{IN} = 2.7\text{ V}$ | | | | 65 | |
| | | Output = High, $V_{IN} = 1.35\text{ V}$ | 25°C | | 30 | 48 | |
| | | Output = Low, $V_{IN} = 1.35\text{ V}$ | | | 35 | 55 | |
| | | Output = High, $V_{IN} = 1.35\text{ V}$ | –40°C to 85°C | | | 55 | |
| | | Output = Low, $V_{IN} = 1.35\text{ V}$ | | | | 65 | |
| A_{VD} | Voltage gain | $V_D = 1.7\text{ V}$, $0.5\text{ V} \leq V_{OUT} \leq 2.2\text{ V}$ | 25°C | | 88 | | dB |
| I_{sink} | Sink current | $V_{OL} = 0.5\text{ V}$ | 25°C | 13 | 18 | | mA |
| | | | –40°C to 85°C | 11 | | | |
| I_{source} | Source current | $V_{OH} = 2.2\text{ V}$ | 25°C | 15 | 20 | | mA |
| | | | –40°C to 85°C | 13 | | | |
| V_{OL} | Low-level output voltage | $I_{sink} = 5\text{ mA}$ | 25°C | | 0.11 | 0.16 | V |
| | | | –40°C to 85°C | | | 0.19 | |
| V_{OH} | High-level output voltage | $I_{source} = 5\text{ mA}$ | 25°C | 2.54 | 2.60 | | V |
| | | | –40°C to 85°C | 2.45 | | | |

Electrical Characteristics

$V_{CC+} = 1.8\text{ V}$, $V_{CC-} = \text{GND}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | T_A | MIN | TYP | MAX | UNIT | |
|--------------|-----------------------------|--|---------------|-----|-----|----------------|---------------|--|
| V_{IO} | Input offset voltage | | 25°C | | ±2 | ±8 | mV | |
| | | | -40°C to 85°C | | | ±9 | | |
| I_{IO} | Input offset current | | 25°C | | 2 | | pA | |
| I_I | Input bias current | | 25°C | | 4 | | pA | |
| V_{CM} | Common-mode input voltage | | 25°C | 0 | | $V_{CC} - 0.3$ | V | |
| CMRR | Common-mode rejection ratio | $\Delta V_{CM} = 5\text{ V}$ | 25°C | 40 | 55 | | dB | |
| | | $0 \leq V_{CM} \leq 5\text{ V}$ | -40°C to 85°C | 40 | | | | |
| I_{CC} | Supply current | Output = High, $V_{IN} = 1.8\text{ V}$ | 25°C | | 30 | 55 | μA | |
| | | Output = Low, $V_{IN} = 1.8\text{ V}$ | | | 33 | 47 | | |
| | | Output = High, $V_{IN} = 1.8\text{ V}$ | -40°C to 85°C | | | 60 | | |
| | | Output = Low, $V_{IN} = 1.8\text{ V}$ | | | | 51 | | |
| | | Output = High, $V_{IN} = 0.9\text{ V}$ | 25°C | | 20 | 32 | | |
| | | Output = Low, $V_{IN} = 0.9\text{ V}$ | | | 25 | 37 | | |
| | | Output = High, $V_{IN} = 0.9\text{ V}$ | -40°C to 85°C | | | 34 | | |
| | | Output = Low, $V_{IN} = 0.9\text{ V}$ | | | | 40 | | |
| A_{VD} | Voltage gain | $V_D = 1.1\text{ V}$, $0.4\text{ V} \leq V_{OUT} \leq 1.5\text{ V}$ | 25°C | | 88 | | dB | |
| I_{sink} | Sink current | $V_{OL} = 0.5\text{ V}$ | 25°C | 6 | 9 | | mA | |
| | | | -40°C to 85°C | 5 | | | | |
| I_{source} | Source current | $V_{OH} = 2.2\text{ V}$ | 25°C | 5 | 9 | | mA | |
| | | | -40°C to 85°C | 4 | | | | |
| V_{OL} | Low-level output voltage | $I_{sink} = 5\text{ mA}$ | 25°C | | 0.2 | 0.34 | V | |
| | | | -40°C to 85°C | | | 0.39 | | |
| V_{OH} | High-level output voltage | $I_{source} = 5\text{ mA}$ | 25°C | 1.3 | 1.6 | | V | |
| | | | -40°C to 85°C | 1.2 | | | | |

Switching Characteristics

$V_{CC+} = 5\text{ V}$, $V_{CC-} = \text{GND}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | TYP | UNIT |
|-----------|-----------------------------------|--------------------|-----|------|
| t_{PLH} | Propagation delay time (turn on) | Overdrive = 100 mV | 680 | ns |
| | | TTL step input | 500 | |
| t_{PHL} | Propagation delay time (turn off) | Overdrive = 100 mV | 250 | ns |
| | | TTL step input | 380 | |
| t_{TLH} | Response time | Overdrive = 100 mV | 60 | ns |
| t_{THL} | | | 8 | |

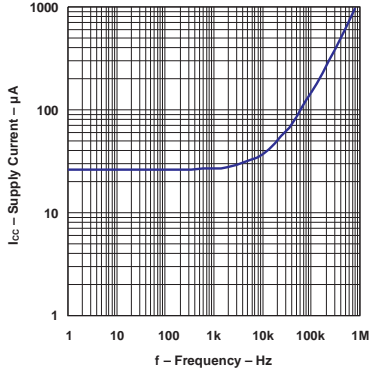
Switching Characteristics

$V_{CC+} = 3\text{ V}$, $V_{CC-} = \text{GND}$, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

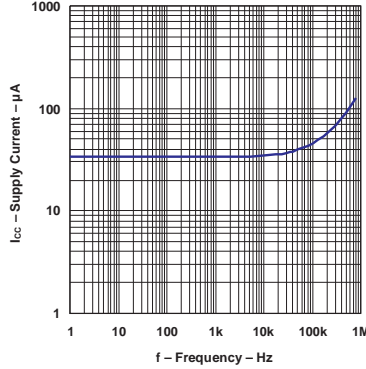
| PARAMETER | | TEST CONDITIONS | TYP | UNIT |
|-----------|-----------------------------------|--------------------|-----|------|
| t_{PLH} | Propagation delay time (turn on) | Overdrive = 100 mV | 550 | ns |
| t_{PHL} | Propagation delay time (turn off) | Overdrive = 100 mV | 250 | ns |
| t_{TLH} | Response time | Overdrive = 100 mV | 30 | ns |
| t_{THL} | | | 8 | |

TYPICAL CHARACTERISTICS

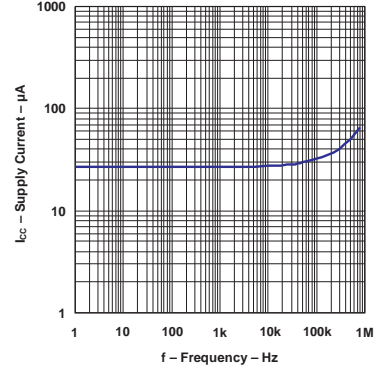
SUPPLY CURRENT
VS
FREQUENCY
 $V_{CC} = 5\text{ V}$



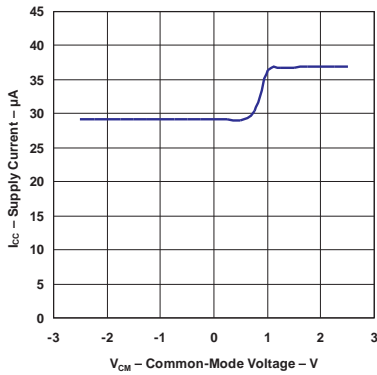
SUPPLY CURRENT
VS
FREQUENCY
 $V_{CC} = 2.7\text{ V}$



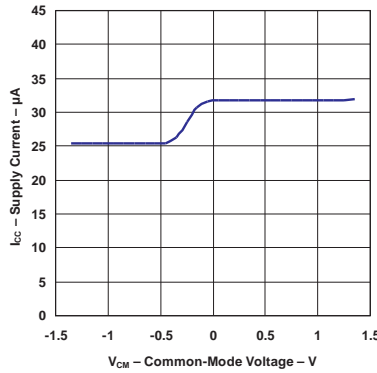
SUPPLY CURRENT
VS
FREQUENCY
 $V_{CC} = 1.8\text{ V}$



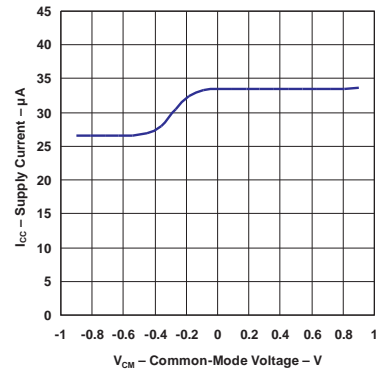
SUPPLY CURRENT
VS
COMMON-MODE VOLTAGE
 $V_{CC} = \pm 2.5\text{ V}$



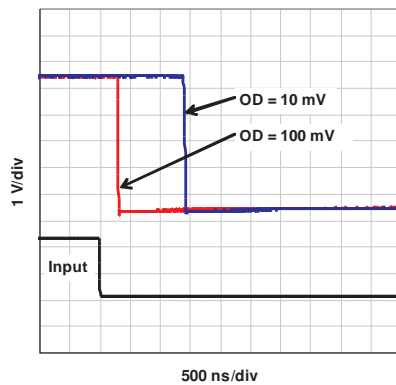
SUPPLY CURRENT
VS
COMMON-MODE VOLTAGE
 $V_{CC} = \pm 1.35\text{ V}$



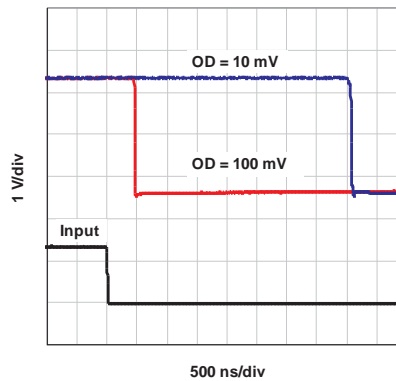
SUPPLY CURRENT
VS
COMMON-MODE VOLTAGE
 $V_{CC} = \pm 0.9\text{ V}$



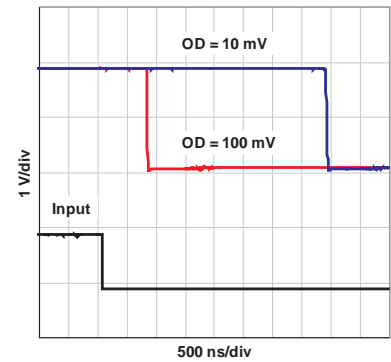
PROPAGATION DELAY TIME,
HIGH TO LOW
 $V_{CC} = 5\text{ V}$



PROPAGATION DELAY TIME,
HIGH TO LOW
 $V_{CC} = 2.7\text{ V}$

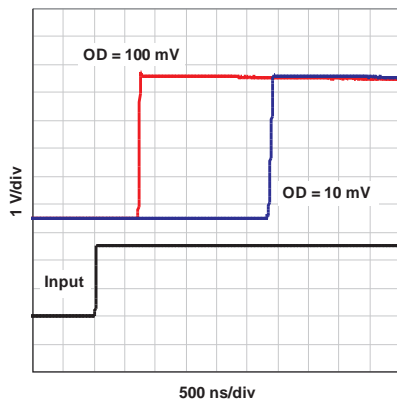


PROPAGATION DELAY TIME,
HIGH TO LOW
 $V_{CC} = 1.8\text{ V}$

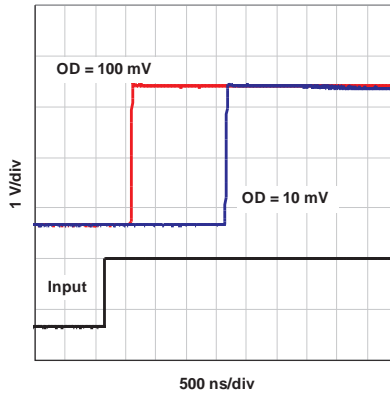


TYPICAL CHARACTERISTICS (continued)

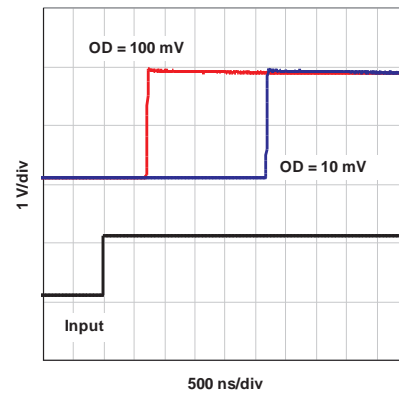
PROPAGATION DELAY TIME,
LOW TO HIGH
 $V_{CC} = 5\text{ V}$



PROPAGATION DELAY TIME,
LOW TO HIGH
 $V_{CC} = 2.7\text{ V}$



PROPAGATION DELAY TIME,
LOW TO HIGH
 $V_{CC} = 1.8\text{ V}$



PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| TLV7256IDDUR | ACTIVE | VSSOP | DDU | 8 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TLV7256IDDURG4 | ACTIVE | VSSOP | DDU | 8 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

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Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

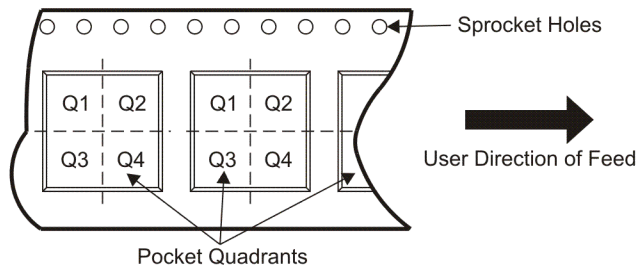
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TAPE AND REEL INFORMATION



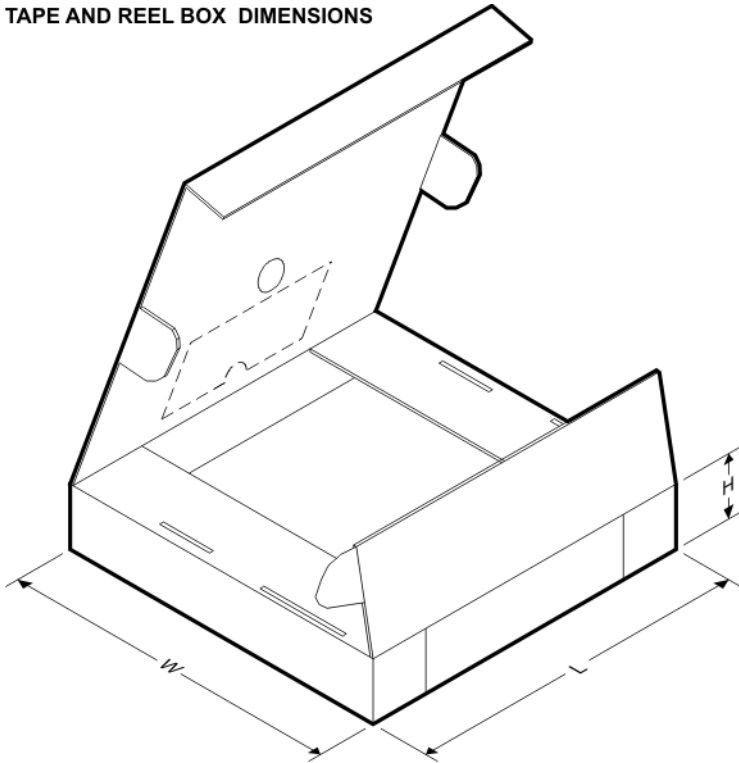
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TLV7256IDDUR | VSSOP | DDU | 8 | 3000 | 180.0 | 9.2 | 2.25 | 3.35 | 1.05 | 4.0 | 8.0 | Q3 |

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TLV7256IDDUR | VSSOP | DDU | 8 | 3000 | 202.0 | 201.0 | 28.0 |

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